

AMP | AMP Twin-Leaf

TE Internal #: 583859-5

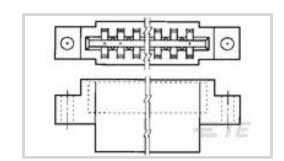
Housing, Receptacle, Wire-to-Board, 18 Position, 3.96 mm [.156 in] Centerline, Crimp, 2 Row, Black, Printed Circuit Board, AMP Twin-

Leaf

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Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings



Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 18

Centerline (Pitch): 3.96 mm [.156 in]

Features

Product Type Features

Connector Product Type	Housing
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Dual Positions	18
Number of Positions	18

Contact Features

Number of Rows

Contact Current Rating (Max)	5 A	

2

Termination Features

Termination Method to Wire & Cable	Crimp
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Mechanical Attachment

Strain Relief	Without
PCB Mount Retention	Without
Panel Mount Feature Type	Mounting Ears
Connector Mounting Type	Board Mount

Housing Features



Housing Material	Polyester GF
Centerline (Pitch)	3.96 mm[.156 in]
Housing Color	Black
Dimensions	
	.75 in
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
Glow Wire Rating	Standard Part - Not Glow Wire
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Carton

Product Compliance Disclaimer

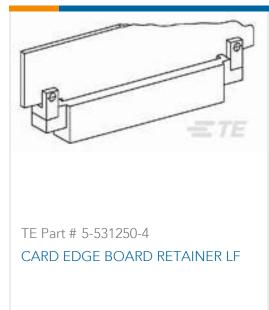
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part



numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







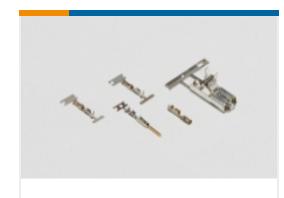
Also in the Series | AMP Twin-Leaf







Wire-to-Board Connector Assemblies & Housings(27)



Wire-to-Board Connector Contacts(15)

Documents

Product Drawings

TW-LF CRP HSG 18 POS

English

Product Specifications

Product Specification

English

Product Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

UL Report

English

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